

Low Power Capacitance-to-Voltage Converter for Magnetometer Interface IC

Dipankar Nag, Choe Andrew Kunil, Kevin Chai Tshun Chuan, and Minkyu Je

Abstract—This paper presents the design and implementation of a fully integrated Capacitance-to-Voltage Converter (CVC) as the analog front-end for magnetometer interface IC. The application demands very low power solution operating in the frequency of around 20 KHz. The design adapts low power architecture to create low noise electronic interface for Capacitive Micro-machined Lorentz force magnetometer sensor. Using a 0.18- μm CMOS process, simulation results of this interface IC show that the proposed CVC can provide 33 dB closed loop gain, 20 nV/ $\sqrt{\text{Hz}}$ input referred noise at 20 KHz, while consuming 65 μA current from 1.8-V supply.

Keywords—Analog front end, Capacitance-to-Voltage Converter, Magnetometer, MEMS, Recycling Folded Cascode.

I. INTRODUCTION

THE growing interest in consumer electronics is to add more features and integrate them in one multipurpose device. Part of this trend, the inclusion of a magnetometer to serve as an electronic compass thereby facilitating navigation and location-based services, is expected to dramatically increase magnetometer demand [1]. Silicon MEMS magnetic field sensors, based on Lorentz force principle, are attractive because, unlike magneto resistive sensors they require no special magnetic materials, and they are much more sensitive than silicon Hall effect sensors [2]. MEMS Lorentz force sensors have the additional advantage of easy integration with other MEMS inertial sensors such as accelerometers, gyroscopes etc.

II. SYSTEM DESCRIPTION

A. Lorentz Force Magnetometer

Fig. 1 shows a generic diagram of Lorentz force magnetometer sensor. If a current “I” is applied in the $-y$ direction of the magnetometer any applied magnetic field, B in the $\pm z$ direction will create a force in the x -axis of the shuttle mass. This force is called Lorentz force is given by (1).

$$F_L = (I \times B)L_{mass} \quad (1)$$

where, F_L is the force applied to the structure, I is the current, B is the out-of-plane magnetic field and L_{mass} is the effective beam length (Fig. 1). The frequency of the current “I” is

intentionally selected to be equal to the mechanical resonance frequency of the mechanical structure to maximize the mechanical response of the sensor. To enhance the total system resolution the quality factor of the sensor structure is kept reasonably high. This approach can be adopted easily as the magnetic field to be measured has bandwidth less than 10 Hz.

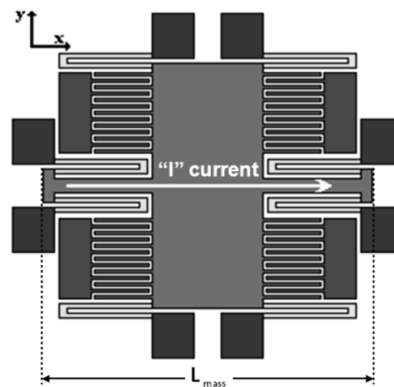


Fig. 1 Lorentz force sensor

This work is supported by MEMS Consortium II program.

Dipankar Nag, Choe Andrew Kunil, Kevin Chai Tshun Chuan and Minkyu Je are with Institute of Microelectronics, Agency for Science, Technology and Research, 11 Science Park Road, Science Park II, Singapore 117685 (e-mail: nagd@ime.a-star.edu.sg, choeak@ime.a-star.edu.sg, chaitc@ime.a-star.edu.sg, jemk@ime.a-star.edu.sg).

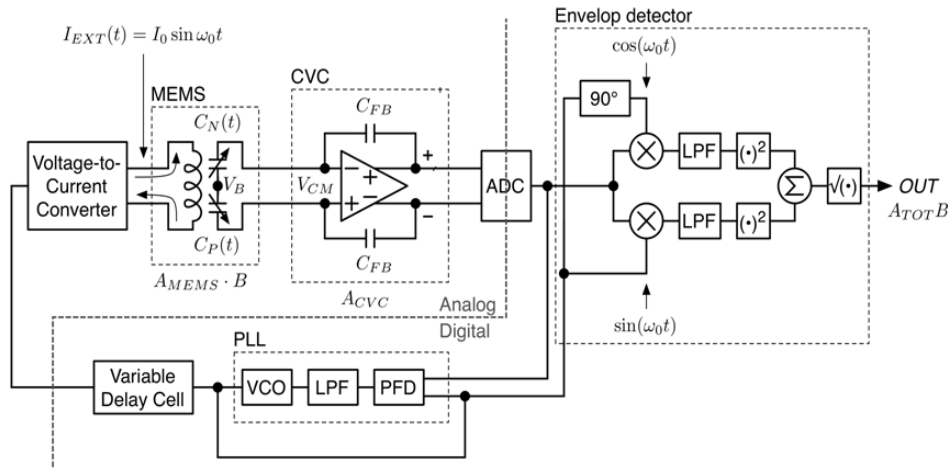


Fig. 2 Magnetometer System

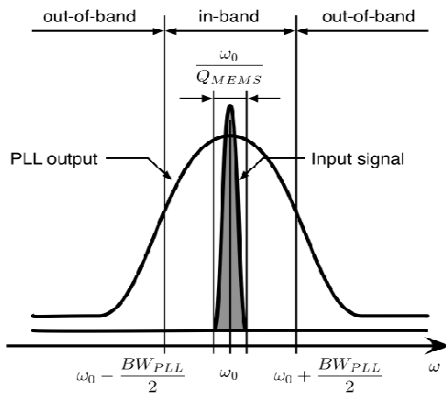


Fig. 3 PSD of PLL input and output

B. System Operation

Fig. 2 shows the system diagram adopted for this design. In order to drive the MEMS with an excitation having frequency same as the MEMS resonant frequency, a closed loop system has been conceptualized. Under the influence of an external magnetic field (B), the proof mass deflects, causing a differential capacitance change, which is converted by a capacitance-to-voltage converter (CVC) to a proportional voltage signal by charge integration. The CVC output is an AM modulated B field, with the MEMS resonance frequency as a carrier. An in-phase/quadrature-phase demodulation method is suggested to obtain a signal proportional to B field.

A phase locked loop (PLL) has been proposed to track the CVC output frequency. The variable delay cell block provides flexibility to search for the desired resonance frequency. The PLL loop bandwidth is chosen to be much higher than MEMS bandwidth (few Hz in this case) and much lower than the MEMS resonant frequency (20 KHz in this case). Under this condition, quality factor of MEMS determines the in-band noise performance. Under lock condition PLL out of band noise becomes less critical. Fig. 3 shows the power spectral density (PSD) of PLL input and output signal under steady

state. In order to achieve robust and flexible performance signal detection and frequency tracking operation takes place in digital domain. An ADC is employed following CVC to convert the signal to digital domain. In this literature we are going to focus on design and implementation of the CVC pertaining to this system.

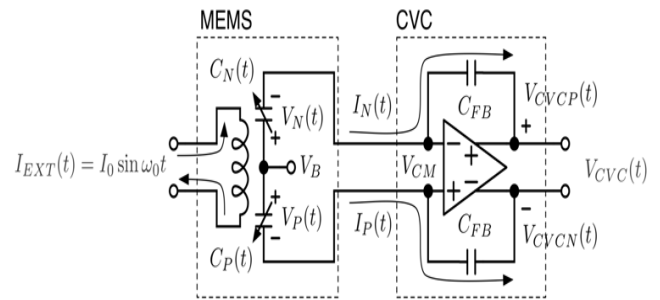


Fig. 4 CVC with MEMS Model

III. CVC CIRCUIT ANALYSIS AND SPECIFICATION

The capacitance-to-voltage converter (CVC) along with the sensor model is shown in Fig. 4. The operating principle has been qualitatively explained in previous section. This section will focus on quantitative formulation of capacitance to voltage conversion in this analog front end. Instantaneous position of the moving comb, measured from the quiescent point (Fig. 5) is given by (2).

$$d(t) = \frac{F_L(t)}{k} = \frac{LN_{coil}}{k} I_{EXT}(t) B = A_{d0} I_{EXT}(t) B \quad (2)$$

Here,

$F_L(t)$: Lorentz force

k : spring constant of the MEMS moving comb

L : length of comb that intersects with magnetic field

$I_{EXT}(t)$: excitation current to the coil

B : intensity of the magnetic field
 N_{COIL} : number of turns of the coil

As per Fig. 5, $d_P(t)$ and $d_N(t)$ denote distance from the moving comb to the positive or negative stationary comb, respectively (3).

$$\begin{aligned} d_P(t) &= d_0 - d(t) \\ d_N(t) &= d(t) + d_0 \end{aligned} \quad (3)$$

Now the current $I_N(t)$ (Fig. 4) flowing to CVC can be calculated as given in (4).

$$\begin{aligned} I_N(t) &= C_N(t) \frac{dV_N(t)}{dt} + V_N(t) \frac{dC_N(t)}{dt} \\ &= (V_B - V_{CM}) \frac{dC_N(t)}{dt} \end{aligned} \quad (4)$$

Here, $C_N(t)$, instantaneous capacitance of one half of the sensor (Fig. 4), is given by (5).

$$C_N(t) = \frac{\epsilon_0 \bullet \text{area}}{d_0 + A_{d0} I_0 B \sin(\omega_0 t + \phi_{MEMS})} \quad (5)$$

where, ϕ_{MEMS} is the phase delay due to MEMS.

The voltage after charge integration at one output of CVC can be found as shown in (6).

$$\begin{aligned} V_{CVCp}(t) &= V_{CM} - \frac{1}{C_{FB}} \int_{-\infty}^t I_N(\tau) d\tau \\ &= V_{CM} - \frac{V_B - V_{CM}}{C_{FB}} (C_N(t) - C_N(\infty)) \end{aligned} \quad (6)$$

Here, $C_N(\infty)$ is rest capacitance, C_0 . Similarly, we can deduce for $V_{CVCN}(t)$ and assuming symmetry final CVC output, $V_{CVC}(t)$, can be approximated as follows.

$$\begin{aligned} V_{CVC}(t) &\approx 2 \left[\frac{\epsilon_0 \bullet \text{area}}{d_0} \right] \left[\frac{A_{d0} I_0 B}{d_0} \right] \left[\frac{V_B - V_{CM}}{C_{FB}} \right] \sin(\omega_0 t + \phi_{MEMS} + \phi_{CVC}) \\ &= 2 C_0 \frac{d_{max}}{d_0} A_{CVC} \sin(\omega_0 t + \phi_{MEMS} + \phi_{CVC}) \end{aligned} \quad (7)$$

Here, A_{CVC} and ϕ_{CVC} denote CVC gain and CVC phase delay respectively. Finally, d_{max}/d_0 signifies normalized MEMS comb displacement with respect to quiescent displacement. Thus it is justified in (7) that the CVC output is an AM modulated B field, with the MEMS resonance as a carrier.

So far the amplifier in CVC has been assumed to be ideal. Due to finite gain bandwidth of the amplifier CVC gain reduces from its ideal value described in (7). Incorporating the gain error, non-ideal CVC gain is shown in (8).

$$\begin{aligned} A_{CVC} &= \frac{V_B - V_{CM}}{C_{FB}} \left[1 - \frac{C_T}{C_{FB} A_0} \right] \\ C_T &= C_{FB} + C_0 + C_{par} \end{aligned} \quad (8)$$

Here, A_0 and C_{par} denote amplifier open loop gain (at f_0) and parasitic capacitance at input node. Considering the parameter values from sensor model, $C_0=2.5$ pF, $C_{par}=2$ pF, $V_B=0$, $V_{CM}=0.9$ V, $f_0=20$ KHz, we plot CVC gain for different gain-bandwidth (GBW) of amplifier in Fig. 6. Negative value in this plot does not occur physically. In physical world it means transduction operation completely fails. From this plot, we target GBW of more than 5 MHz for C_{FB} in the range of 50fF-100 fF to achieve CVC gain of 8 pF/V. This translates to around 30 dB of closed loop voltage gain to be achieved from the amplifier.

The amplifier noise plays a significant role in system resolution. The input referred noise power $\overline{v_n^2}$ is transformed to output noise power following the relation (9).

TABLE I
CVC SPECIFICATION

Symbol	Quantity	Value
GBW	Amplifier Open loop Gain Bandwidth	5 MHz
A_0	Amplifier Open Loop Gain at 20 KHz	48 dB
v_n	Input Noise Density at 20 KHz	20 nV/ $\sqrt{\text{Hz}}$
A_{CVC}	CVC Gain	8pF/V
P	Power Consumption	125 μ Watt
A	Area	400 μm X 400 μm

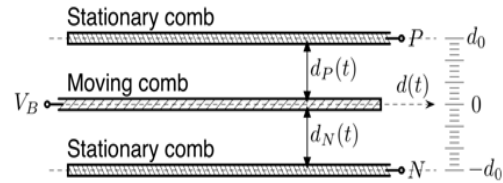


Fig. 5 Measurement in MEMS sensor

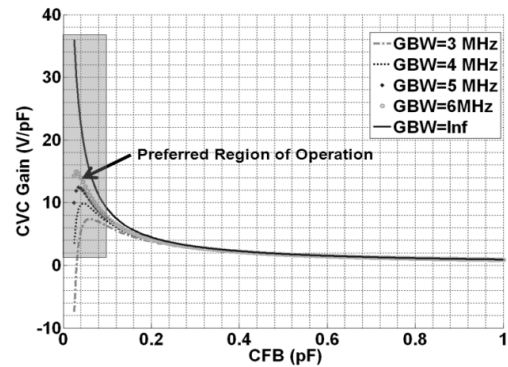
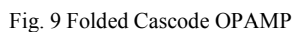


Fig. 6 CVC Gain versus C_{FB} for different GBW of amplifier

$$\overline{v_{no}^2} = \left(\frac{C_T}{C_{FB}} \right)^2 \overline{v_n^2} \quad (9)$$

IV. CIRCUIT DESIGN

1173



This inefficiency has been addressed by proposing recycling folded cascode (RFC) topology in [4] (Fig. 10 (a)). Here the input differential pair, $M1$ and $M2$ (Fig. 10 (a)), are split in half to produce transistors $M1a$, $M1b$, $M2a$, and $M2b$ (Fig. 10 (a)). Next, $M3$ and $M4$ are split to form the current mirrors $M3a:M3b$ and $M4a:M4b$ with a ratio of $K:1$, where K is

[illegible]

Fig. 11 CVC Lay-out

Fig. 10 (b) shows differential difference amplifier (DDA) used to generate common-mode feedback (CMFB) for the output.

V. SIMULATION RESULTS

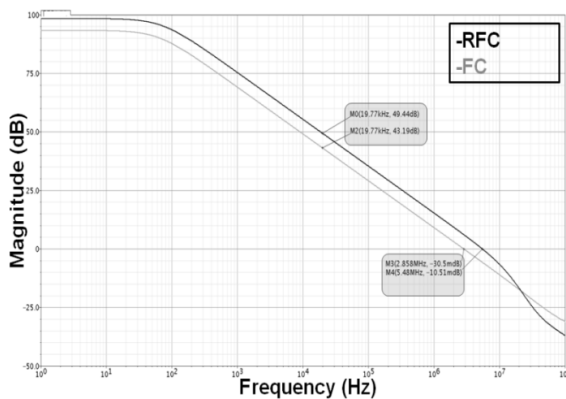
Fig. 12 shows open loop frequency response of RFC OPAMP. It can achieve 5.5 MHz GBW while burning 65 μ A current from 1.8 V supply. The open loop gain 20 KHz appears to be ~ 50 dB. A similar FC OPAMP has also been designed. Under same power consumption FC OPAMP can only achieve a GBW half of achieved by RFC topology (Fig. 12 (a)). Fig. 13 shows spectral density of input referred noise for both the topologies. In terms of noise both appears to have comparable performance. Table II summarises relevant

parameters pertaining to RFC and FC OPAMP under same power consumption. This justifies the use of RFC OPAMP in the current design.

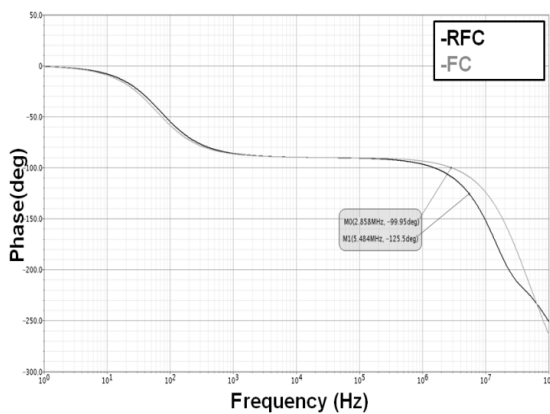
TABLE II
RFC AND FC COMPARISON

Parameter	RFC	FC
GBW (MHz)	5.5	2.85
A_0 (dB)	49.4	43.4
v_n (nV/ $\sqrt{\text{Hz}}$)	17.5	18
Phase Margin (Deg)	55	80

Finally, the CVC frequency response is characterized with MEMS model. Fig. 14 shows the frequency response for both pre-layout and post-layout simulation. Approximately 33 dB of closed loop gain at 20 KHz appears in line with our specification.



(a)



(b)

Fig. 12 Amplifier AC response (a) magnitude (b) phase

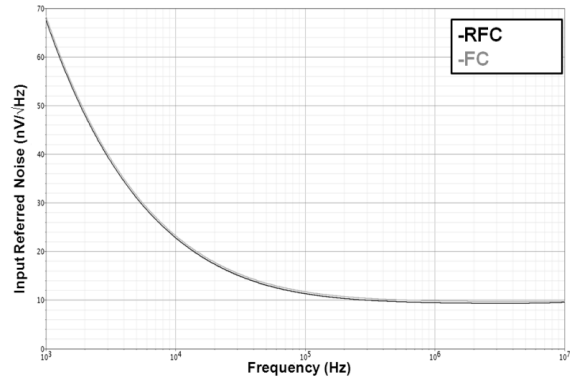


Fig. 13 Amplifier Input Noise spectral density

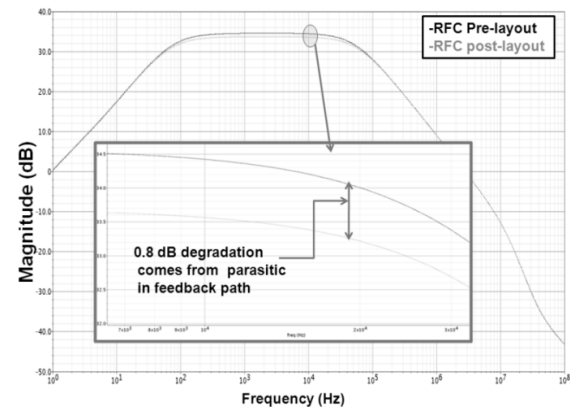


Fig. 14 CVC frequency response

VI. CONCLUSION

We present the design and implementation of a fully integrated capacitance-to-voltage converter dedicated to interface Lorentz force magnetometer sensor using 0.18- μm CMOS technology from Global Foundries. New fully integrated low power low noise CVC has been described. Simulation results validate its ability to meet the specifications. The proposed circuit has been sent for fabrication and measurements will be done when the prototypes are ready.

REFERENCES

- [1] J. Bouchaud, *Silicon Magnetic Sensor Market Offers Attractive Growth*. El Segundo, CA: I Suppli, 2008, p. 1.
- [2] M. J. Thompson and D.A. Horsley, "Parametrically Amplified Z-Axis Lorentz Force Magnetometer," *IEEE J. Microelectromechanical Systems*, vol. 20, no. 3, pp. 702–710, Jun. 2011.
- [3] J. Holleman and B. Otis, "A Sub-Microwatt Low-Noise Amplifier for Neural Recording," in *Proc. 29th Annu. Int. Conf. IEEE Eng. Med. Biol. Soc.*, Aug. 2007, pp. 45–48.
- [4] R. S. Assaad and J. Silva-Martinez, "The recycling folded cascode: A general enhancement of the folded cascode amplifier," *IEEE J. Solid-State Circuits*, vol. 44, no. 9, pp. 2535–2542, Sep. 2009.